

12. Reference Information

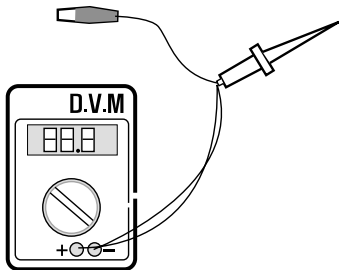
This chapter contains the tools list, list of abbreviations used in this manual, and a guide to the location space required when installing the printer. A definition of test pages and Wireless Network information definition is also included.

12.1 Tool for Troubleshooting

The following tools are recommended safe and easy troubleshooting as described in this service manual.

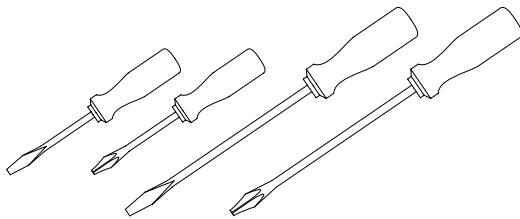
- **DVM (Digital Volt Meter)**

Standard : Indicates more than 3 digits.



- **Driver**

Standard : "-" type, "+" type (M3 long, M3 short, M2 long, M2 short).



- **Tweezers**

Standard : For general home use, small type.



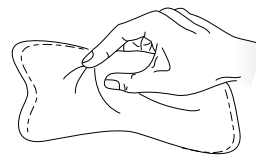
- **Cotton Swab**

Standard : For general home use, for medical service.

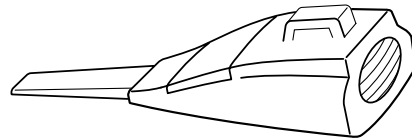


- **Cleaning Equipments**

Standard : An IPA (Isopropyl Alcohol) dry wipe tissue or a gentle neutral detergent and lint-free cloth.



- **Vacuum Cleaner**

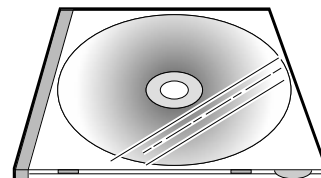


- **Spring Hook**

Standard : For general use



- **Software (Driver) installation CD ROM**



12.2 Acronyms and Abbreviations

The table below explains abbreviations used in this service manual.

The contents of this service manual are declared with abbreviations in many parts. Please refer to the table.

12.2.1 General

AC	Alternating Current	IC	integrated circuit
ADF	Automatic Document Feeder	IDE	Intelligent Drive electronics or Imbedded Drive Electronics
ASIC	Application Specific Integrated Circuit	IEEE	Institute of Electrical and Electronics Engineers. Inc
ASSY	assembly	IPA	Isopropyl Alcohol
BIOS	Basic Input Output System	IPM	Images Per Minute
CCD	Charge Coupled Device	LAN	local area network
CMOS	Complementary Metal Oxide Semiconductor	lb	pound(s)
CN	connector	LBP	Laser Beam Printer
CON	connector	LCD	Liquid Crystal Display
CPM	Copies Per Minute	LED	Light Emitting Diode
CPU	Central Processing Unit	LSU	Laser Scanning Unit
CRU	Customer Replaceable Unit	MB	Megabyte
CRUM	CRU Memory	MFP	Multi-Functional Product
dB	decibel	MHz	Megahertz
dbA	decibelampere	MP	Multi Purpose
dBm	decibel milliwatt	NVRAM	Nonvolatile random access memory
DADF	Duplex Auto Document Feeder(=DADH)	OPC	Organic Photo Conductor
DC	direct current	PBA	Printed Board Assembly
DCU	Diagnostic Control Unit	PCL	Printer Command Language , Printer Control Language
DPI	Dot Per Inch	PDL	Page Discription Language
DRAM	Dynamic Random Access Memory	PPM	Page Per Minute
DVM	Digital Voltmeter	PS/3	Post Script Level-3
ECM	Error Correction Mode	PTL	Pre-Transfer Lamp
ECP	Enhanced Capability Port	Q'ty	Quantity
EEPROM	Electronically Erasable Programmable Read Only Memory	RAM	Random Access Memory
EMI	Electro Magnetic Interference	ROM	Read Only Memory
EP	electrophotographic	SCF	Second Cassette Feeder
EPP	Enhanced Parallel Port	SMPS	Switching Mode Power Supply
FCOT	First Copy Out Time	SPGP	Samsung Printer Graphic Processor
FPOT	First Print Out Time	SPL	Samsung Printer Language
F/W	firmware	Spool	Simultaneous Peripheral Operation Online
GDI	graphics device interface	SW	Switch
GND	ground	Sync	Synchronous or synchronization
HBP	Host Based Printing	TBD	To Be Determined
HDD	Hard Disk Drive	USB	Universal Serial Bus
HV	high voltage	W x D x H	Width x Depth x Height
HVPS	High Voltage Power Supply		
I/F	interface		
I/O	Input and Output		

12.2.2 Service Parts

ACRONYM	EXPLANATION
ELA HOU-SCANNER ASS'Y	ELA=Electrical Assembly, HOU =Housing
MEA UNIT-COVER PA EXIT ASS'Y	MEA= Mechanical Assembly, PA=Paper
PMO-TRAY EXTENTION MP NE	PMO= Processing Mold MP=Multi-Purpose(Bypass) tray NE=for NEC (common as Samsung Halk printer)
MEC-CASSETTE ASS'Y(LETTER)	MEC = Mechanic Combined unit
COVER-M-FRONT	M=Mold
MPR-NAME/PLATE	MPR= Machinery Press,
UNIT-LSU	LSU =Laser Scanning Unit
SMPS-SMPS(V1)+HVPS	SMPS =Switching Mode Power Supply HVPS =High Voltage Power Supply
ELA-OPC UNIT SET	OPC=Organic Photo-Conductive
ELA HOU-MP ASS'Y	MP =Multi-Purpose (Bypass) tray
PBA MAIN-MAIN	PBA =Printed circuit Board Assembly
PMO-CONNECT PAPER MFP	MFP =Multi-Functional Peripheral
FAN-DC	DC =Direct Current
CBF POWER STITCH GRAY	CBF= Cable Form
MEA UNIT GUIDE CST PA ASS'Y	CST=Cassette(Paper tray), PA=Paper
PBA LIU	PBA =Printed circuit Board Assembly LIU =Line Interface Unit for FAX
SHIELD-P_MAIN LOWER	P=Press
CBF HARNESS-LIU GND	LIU =Line Interface Unit for FAX GND= Ground
PMO-COVER FEED AY	AY=Assembly
PMO-COVER BRKT MOTER	BRKT=Bracket
CBF HARNESS-LSU	LSU =Laser Scanning Unit
IPR-SHIELD SMPS UPPERI	IPR=Iron Press
PMO-BUSHING P/U.MP	P/U=Pickup MP=Multi-Purpose (Bypass) Tray
PMO-HOLDER GEAR TRr	TR= Transfer Roller
SPRING ETC-TR_L	TR_L=Transfer Roller - Left

ACRONYM	EXPLANATION
PMO-CAM JAM REMOVE	PMO-CAM= Processing Mold-CAM
PMO-LOCKER DEVE	DEVE=Developer
SPECIAL SCREW(PANNEL MFP)	MFP =Multi-Functional Peripheral
A/S MATERAL-DUMMY UPPER ASS'Y	A/S=After-Service
MCT-GLASS ADF	MCT= Machinery Cutting ADF=Automatic Document Feeder
PPR-REGISTRATION EDGE(F)	PPR= Processing Press
IPR-HOLDER GLASSI	PR=Iron Press
MCT-GLASS SCANNER(LEGAL)	MCT= Machinery Cutting
CBF HARNESS-OPE	OPE=Operation Panel(Control Panel)
PBA SUB-D_SUB	PBA SUB-D_SUB =>Sub Printed circuit Board Assembly for the D-SUB type electrical connector (D-Sub) a kind of the connector type(shape 'D')
COVER-M-CCD CABLE	M=Mold CCD=Charge Coupled Device
COVER-SCAN LOWER(UMAX)	UMAX=> Supplier's name for CCD module
ICT-INSERT SHAFTI	ICT= Iron Cutting
IPR-BRK SCAN BD	IPR=Iron Press BRK=Bracket BD= Board
CBF SIGNAL-CCD FFC	CCD = Charge Coupled Device FFC =Flexible Flat Cable
COVER-M-OPE	M=Mold OPE=Operation Panel(Control Panel)
KEY-M-COPY	M=Mold
PLATE-M-ALPHA KEY	M=Molde ALPHA=Alphabet
PMO-GUIDE DP SIDE	DP=Duplex
RING-CS	CS= Compress
GEAR-MP/DUP DRV	MP =Multi-Purpose (Bypass) tray DUP DRV = Duplex Driver
IPR-BRKT G DUPI	PR=Iron Press BRKT=BRACKET G= Ground DUP=Duplex
PMO-BUSHING TX(B4)	TX=Transmit
PMO-TRAY CASE, MP	MP=Multi-Purpose tray(Bypass tray)

ACRONYM	EXPLANATION
SPRING CS RE	CS=Compress RE=Rear
SPRING CS FR	CS=Compress FR=Front
PMO-BUSHING FINGER, F	F=Front
ICT-SHAFT-EXIT LOWER ID	ID=Idler
SPRING-EXIT ROLL FD	FD=Face Down
PMO-BUSHING_P/U,MP	P/U=Pickup MP =Multi-Purpose (Bypass) tray
PMO-HOLDER CAM MPF	MPF=Multi-Purpose Feeder(=MP)
PMO-GEAR P/U MPF	P/U=Pickup
MFP =Multi-Functional Peripheral	
RPR-RUBBER PICK UP,MP	RPR=Rubber Press
PBA SUB-MP SEN	PBA SUB-MP-SEN =>Sub Printed circuit Board Assembly for the MP-SEN(= Multi-Purpose (Bypass) tray-Sensor)
A/S MATERIAL-PICKUP,MP	
FOOT-ML80	
HOLDER CATCH CST MC2	MC2=>McKinley2 (Samsung Project code name)
IPR-GROUND PLATE A(OPC)	OPC=Organic Photo-Conductive
ELA M/M-AUD SPEAKER	ELA M/M => Electrical Assembly M/M AUD=Audio
CBF HARNESS-OPC GND	OPC GNG=Organic Photo-Conductive-Ground
IPR-GROUND PLATE SCF	SCF=Second Cassette Feeder(Tray2)
PBA SUB-PTL	PBA SUB-PTL=>Sub Printed circuit Board Assembly for the PTL(= Pre Transfer Lamp)
PBA SUB-FEED+P.EMP SEN.	PBA SUB-FEED=>Sub Printed circuit Board Assembly for the feeder EMP SEN=Empty Sensor
MOTOR STEP-MCK2(MAIN)	
GEAR-EXIT/U	EXIT/U=EXIT/Upper
GEAR-RDCN FEED INNER	RDCN=Reduction
CBF-HARNESS-MAIN-THV WIRE	THV =Transfer High Voltage
CBF-HARNESS-MAIN-MHV WIRE	MHV= High Voltage(Charge Voltage)

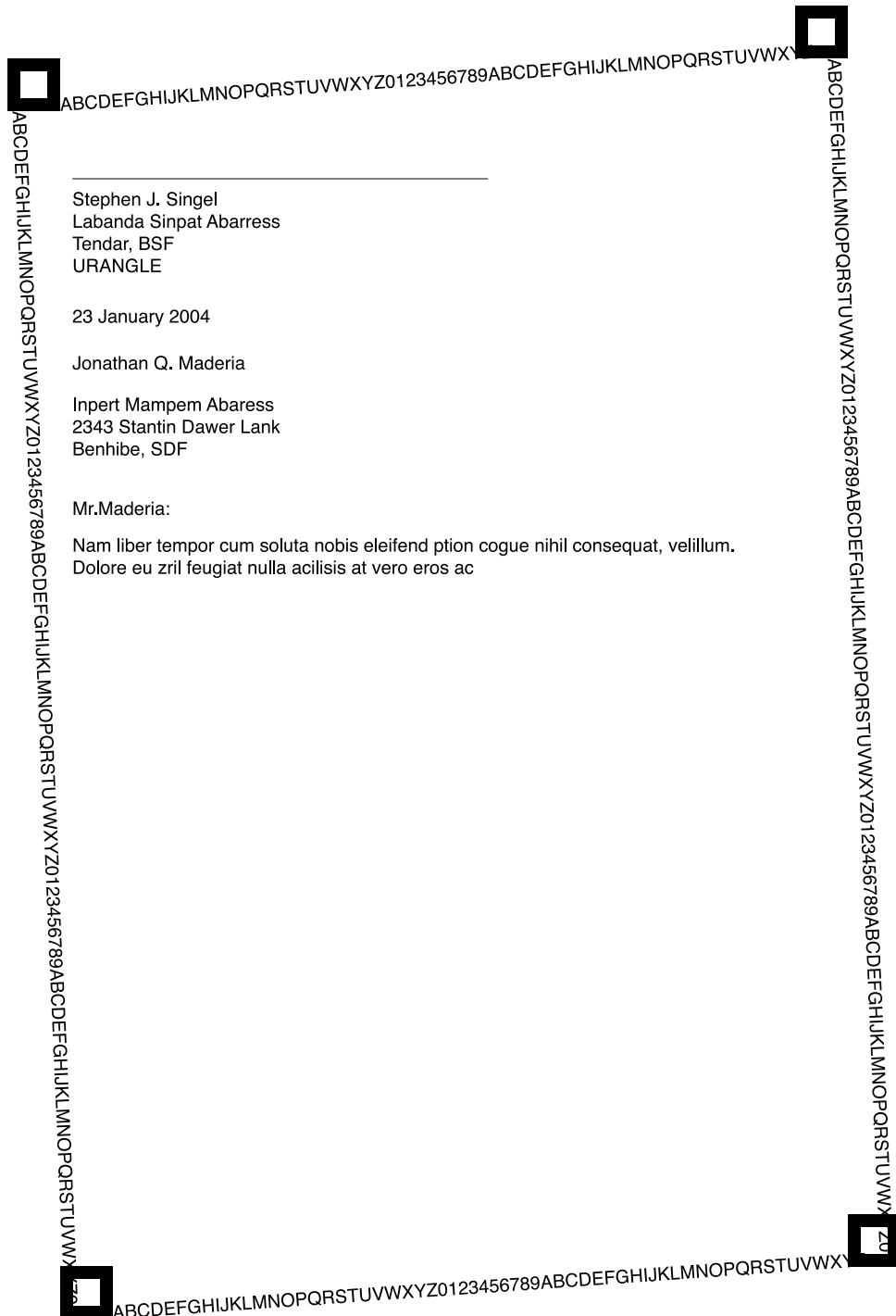
ACRONYM	EXPLANATION
GEAR-EXIT/U,ID	U=Upper ID=Idler
IPR-TERMINAL FU	FU=Fuser
PMO-BEARING H/R-F	H/R-F=Heat Roller - Front
BEARING-H/R L	H/R-L=Heat Roller -Left
PEX-ROLLER EXIT F_UP	PEX= Processing Extrude F_UP=Face Up
SPRING ETC-P/R	P/R=Pressure Roller
SPRING(R)-CAU-HOT-FU	CAU-HOT-FU = Caution Hot -Fuser
PMO-ARM ACTUATOR	PMO-ARM= Processing Mold Arm
LABEL(R)-HV FUSER	HV=High Voltage (220V)
LABEL(R)-LV FUSER	LV=Low Voltage (110V)
PPR-SPONG SHEET	PPR=Plastic Press
IPR-P_PINCH(SCAN)I	PR-P = Iron Press
ROLLER-REGI	REGI=Registration
PBA SUB-REGI	PBA SUB-REGI => Sub Printed circuit Board Assembly for the Registration
GROUND-P_SCAN ROLLER	GROUND-P =Ground-Press
IPR-GUARD C/O S/W	C/O = Cover Open S/W= Switch
MEA UNIT-TX STACKER	TX =Transmit
IPR-WASHER SPRING CU	CU=Curve

12.3 The Sample Pattern for the Test

The sample pattern shown in below is the standard pattern used in the factory.
The life of the toner cartridge and the printing speed are measured using the pattern shown below.
(The image is 70% of the actual A4 size).

12.3.1 A4 ISO 19752 Standard Patterns

This test page is reproduced at 70% of the normal A4 size



12.4 Wireless LAN

- This product uses a printing function with a wireless LAN, which is an option.
 - The wireless LAN function uses a frequency instead of connecting LAN cable to connect data to an access point for print.
 - For a wireless LAN connection, an AP is needed, It is possible to use wireless LAN onnection with wired LAN. Also, if AP is installed in an office or at home, the wireless LAN function can be simply used.
- Types of desk top PC (or Lap top) that uses the wireless LAN.

Division	Basic type	Recommend type
CPU	Over PENTIUM 233M	PENTIUM 300MHz
MEMORY	Over 64MB	Over 128MB
VIDEO CARD	Over 800X600	Over 1024X768
OS	Over WINDOWS 98	Over WINDOWS ME
INTERFACE CARD	A product has a certificated mark of Wi-Fi™	

• About the certificated mark of Wi-Fi™



- The Wi-Fi™ is a registered trademark of WECA (Wireless Ethernet Compatibility Alliance). Over 50 of a wireless LAN companies are member of it. The most of main wireless networking companies are attending and the main companies are Lucent technologies, Cisco, Intel/Symbol, 3Com, Enterasys (Cabletron), Compaq, IBM, Nokia, Dell, Philips, Samsung electronic, Sony, Intersil, and so on. This mark certifies mutual compatibility among product has Wi-Fi™ (IEEE 802.1) and it is certified as a standard of a wireless LAN market.

12.5 Selecting a location

Select a level, stable place with adequate space for air circulation. Allow extra space for opening covers and trays.

The area should be well-ventilated and away from direct sunlight or sources of heat, cold, and humidity. Do not set the machine close to the edge of your desk or table.

Clearance space

- Front: 482.6 mm (enough space so that the paper tray can be removed)
- Back: 100 mm (enough space for ventilation)
- Right: 300 mm (enough space for ventilation)
- Left: 100 mm (enough space for ventilation)

